Drill Table

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Hit Count</th>
<th>Tool Size</th>
<th>Plated</th>
<th>Hole Type</th>
</tr>
</thead>
<tbody>
<tr>
<td>○</td>
<td>5</td>
<td>7.874mil (0.2mm)</td>
<td>PTH</td>
<td>Round</td>
</tr>
<tr>
<td>7</td>
<td>61</td>
<td>12mil (0.305mm)</td>
<td>PTH</td>
<td>Round</td>
</tr>
<tr>
<td>φ</td>
<td>10</td>
<td>41.339mil (1.05mm)</td>
<td>PTH</td>
<td>Round</td>
</tr>
<tr>
<td>×</td>
<td>4</td>
<td>50mil (1.27mm)</td>
<td>PTH</td>
<td>Round</td>
</tr>
<tr>
<td>□</td>
<td>4</td>
<td>63mil (1.6mm)</td>
<td>PTH</td>
<td>Round</td>
</tr>
<tr>
<td></td>
<td><strong>84 total</strong></td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

ALL ARTWORK VIEWED FROM TOP SIDE
BOARD #: PMP5123
REV: D
SVN REV: Not In VersionControl

LAYER NAME = Drill Drawing

PLDT NAME = Drill Drawing
GENERATED : 4/29/2015 8:18:49 AM
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